EPE FOAM HOT MELT

SW5050

Application: Good bonding property to EPE materials (i.e. foam, board), brings complete protection and buffering on finished products.

Characteristics: Excellent bonding property, fast curing with good thermal stability and temperature resistance. Minimal odor and smell.

Specification:

Polymer basis	Ethylene-VInyl Acetate
Viscosity at 160 °c (mPa s)	8,000 - 9,000
Softening point	90 - 100 °c
Supply form	White transparent in granule
Application temperature	150 - 170 °c

Packaging & Storage: in 25 kg kraft bag. 40 bags/ pallet Shelf life of 24 months, in original package, cool and dry (15-35°C).

Remarks: All data indicated are characteristics represented as average values. Our technical data sheets are revised to represent the latest information. This edition is valid on the date of compilation.

TIANJIN SHENG-WANG ELECTRONIC CHEMICAL PLANT E-mail: sales@swadhesive.com <u>www.swhotmeltglue.com</u>

